

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Sun PARK</td> <td>05/23/2007</td> </tr> <tr> <td>Chun-Gi YOU</td> <td>05/23/2007</td> </tr> </tbody> </table>		Name	Execution Date	Sun PARK	05/23/2007	Chun-Gi YOU	05/23/2007
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Sun PARK	05/23/2007						
Chun-Gi YOU	05/23/2007						
RECEIVING PARTY DATA							
Name:	Samsung Electronics Co., Ltd						
Street Address:	416, Maetan-dong, Yeongtong-gu						
City:	Suwon-si, Gyeonggi-do						
State/Country:	KOREA, REPUBLIC OF						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11756217</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11756217		
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Application Number:	11756217						
CORRESPONDENCE DATA							
Fax Number:	(860)286-0115						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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Total Attachments: 2 source=Assignment_PNK-0458#page1.tif source=Assignment_PNK-0458#page2.tif							

CH \$40.00 11756217

ASSIGNMENT

WHEREAS We, PARK, Sun of 504-1003 Dongsuwon Greenville 5-danji, Jugong Greenville apt., Maetan 3-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea; YOU, Chun-Gi of 105-1205 Gubong Maeul Unam Firstvill apt., Byeongjeom-dong, Hwaseong-si, Gyeonggi-do, Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

THIN FILM TRANSISTOR ARRAY PANEL AND METHOD OF
MANUFACTURING THE SAME

which claims priority to Republic of Korea Application No. 10-2006-0081683 , filed on August 28, 2006 , and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEES"), a corporation organized and existing under the laws of the Country of **Republic of Korea** having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEES, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEES, an assignees of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEES, its successors and assigns; and We do hereby agree that the said ASSIGNEES, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEES, its successors or assigns, and

that We will, at the cost and expense of the said ASSIGNEES fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 23/05/2007

PARK SUN L.S.
PARK, Sun

Date: 23/05/2007

YOU CHUN-GI L.S.
YOU, Chun-Gi